■ microGen Generations of Power™

Robert Andosca, Ph.D. Co-founder, President and CEO

May 27, 2014

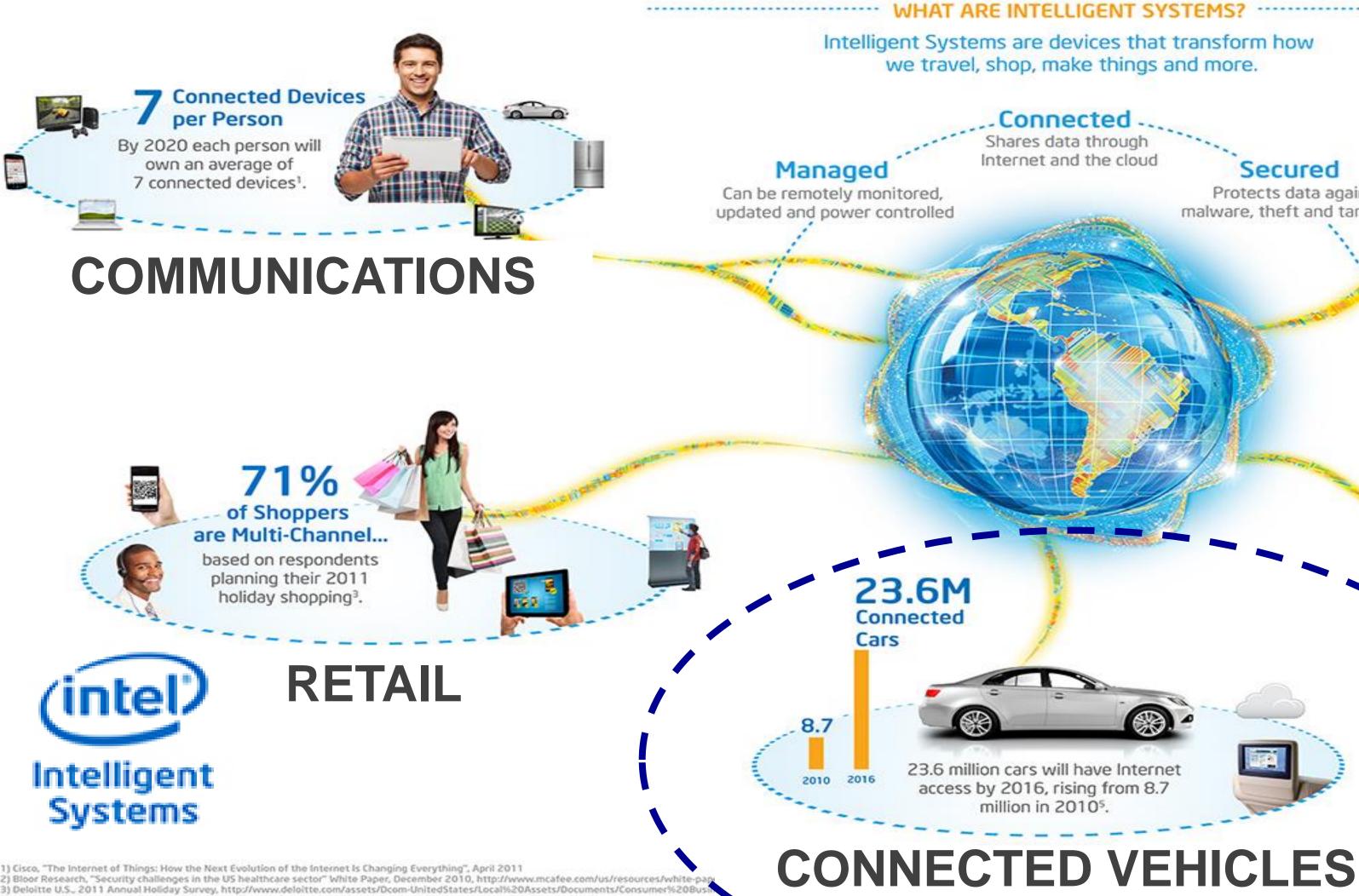


2014 IEEE ECTC (Orlando, FL) presentation



Internet of Things' → Wireless sensors !!

Intelligent Systems for a More Connected World



4) McKinsey Global Institute analysis, "Big data: The next frontier for innovation, competition, and productivity", June 2011) Wall Street Journal, http://online.wsj.com/article/SB10001424052702304066504576349763614933844.html, estimate from research firm, Frost & Schwa

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WHAT ARE INTELLIGENT SYSTEMS?

Intelligent Systems are devices that transform how we travel, shop, make things and more.



#2 Data Breach

Medical data disclosure is the second most breached source of data².

MEDICAL/HEALTH

INDUSTRIAL AND

BUILDING

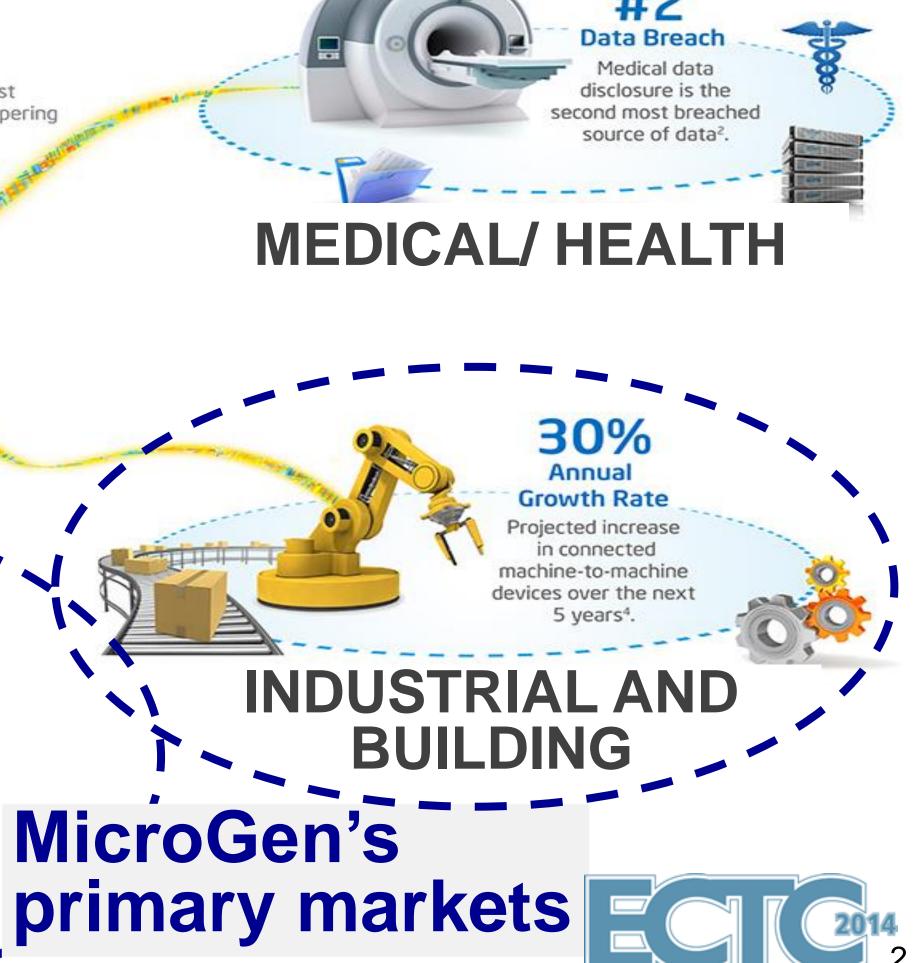
MicroGen's

30% Annual **Growth Rate**

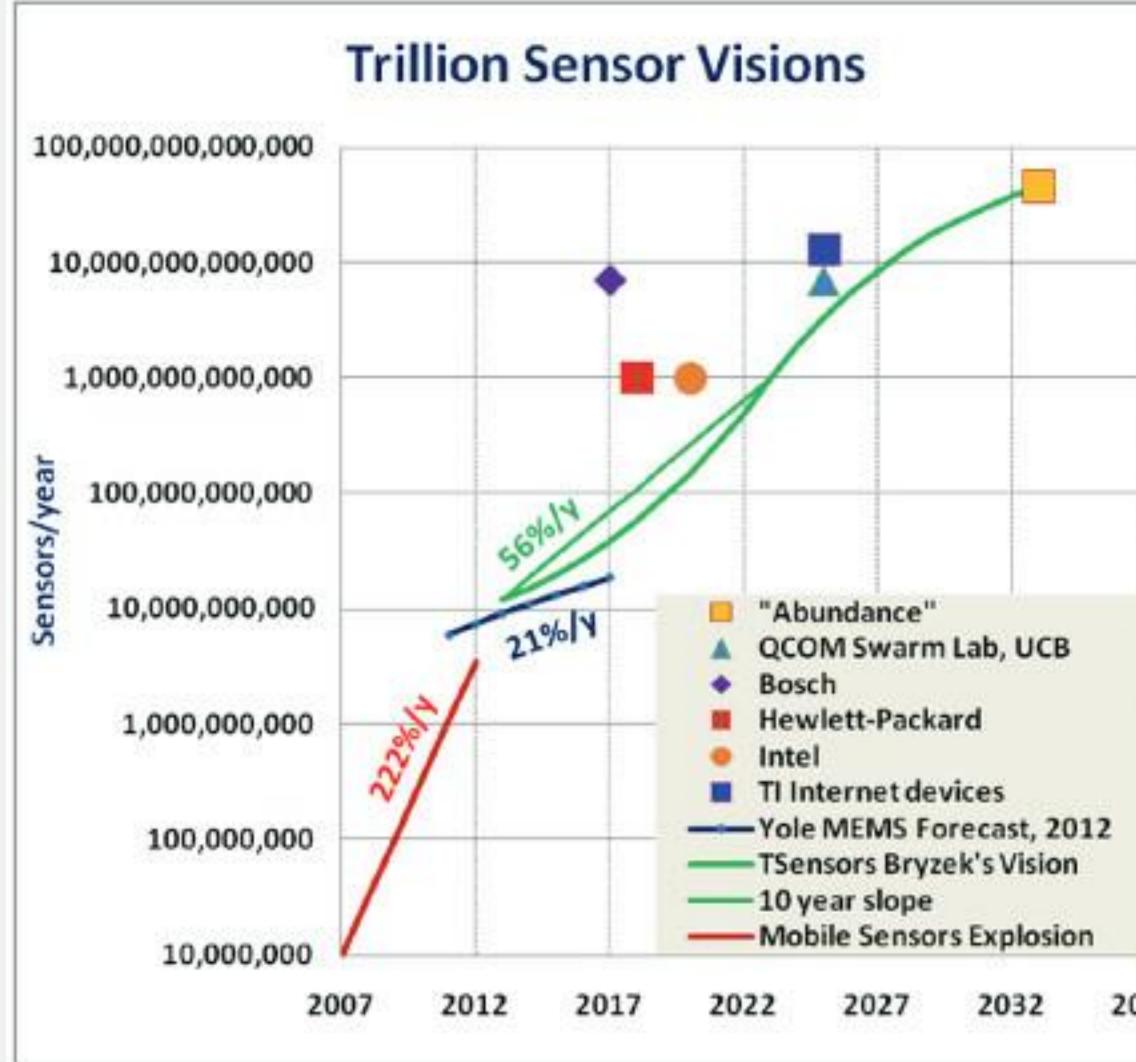
Projected increase in connected machine-to-machine devices over the next 5 years4.

23.6 million cars will have Internet access by 2016, rising from 8.7 million in 20105.





IoT problem: Battery life !!!

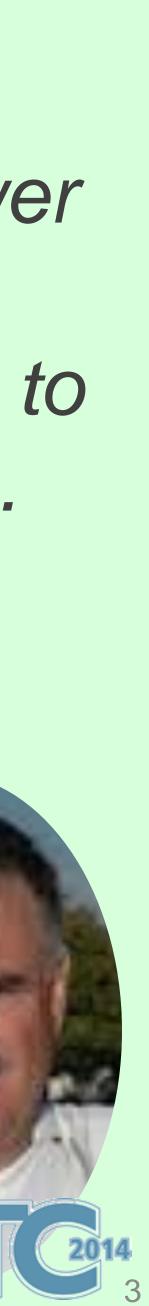


Source: T-sensor Summit, Stanford University, Oct 23-25 2013 May 27, 2014

"Energy is a challenge. To power trillions of sensors requires energy and per unit it will have to be reduced from today's levels. It will need to be derived from light, vibration, thermal energy scavengers."

– Janusz Brysek, Ph.D. **Chairperson Trillion Sensor** Summit and VP MEMS/Sensors **Fairchild Semiconductor**

Source: <u>EE Times</u>, Nov 11, 2013





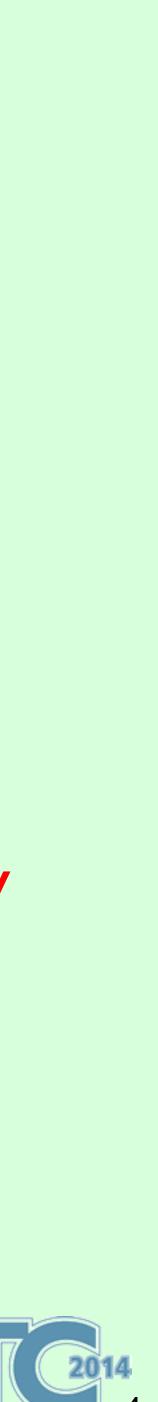
Source: IDTechEx (January 2014)

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- Energy harvesting (EH) types:
- 24% Vibration piezoelectric
 - 20% Vibration induction
 - 10% Solar
 - 46% Thermal

Currently \$\$\$





Current IoT power sources comparison



Induction vibration – large

- Magnetic \vec{B} -fields do not scale well: 10X size reduction \rightarrow 10⁴ \vec{B} -field reduction
- Difficult to fabricate at micro-scale
- \diamond e.g. coils are costly to make and low permeability $\rho\,$ of thin-film magnetic



Thermal energy generators – large

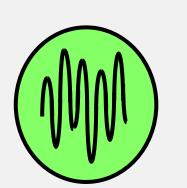
- ✓ Non-standard materials MicroPelt built dedicated fab
- \checkmark Requires large cooling fins and heat sinks



Small-scale solar – moderately small

 \checkmark Low power generation indoors

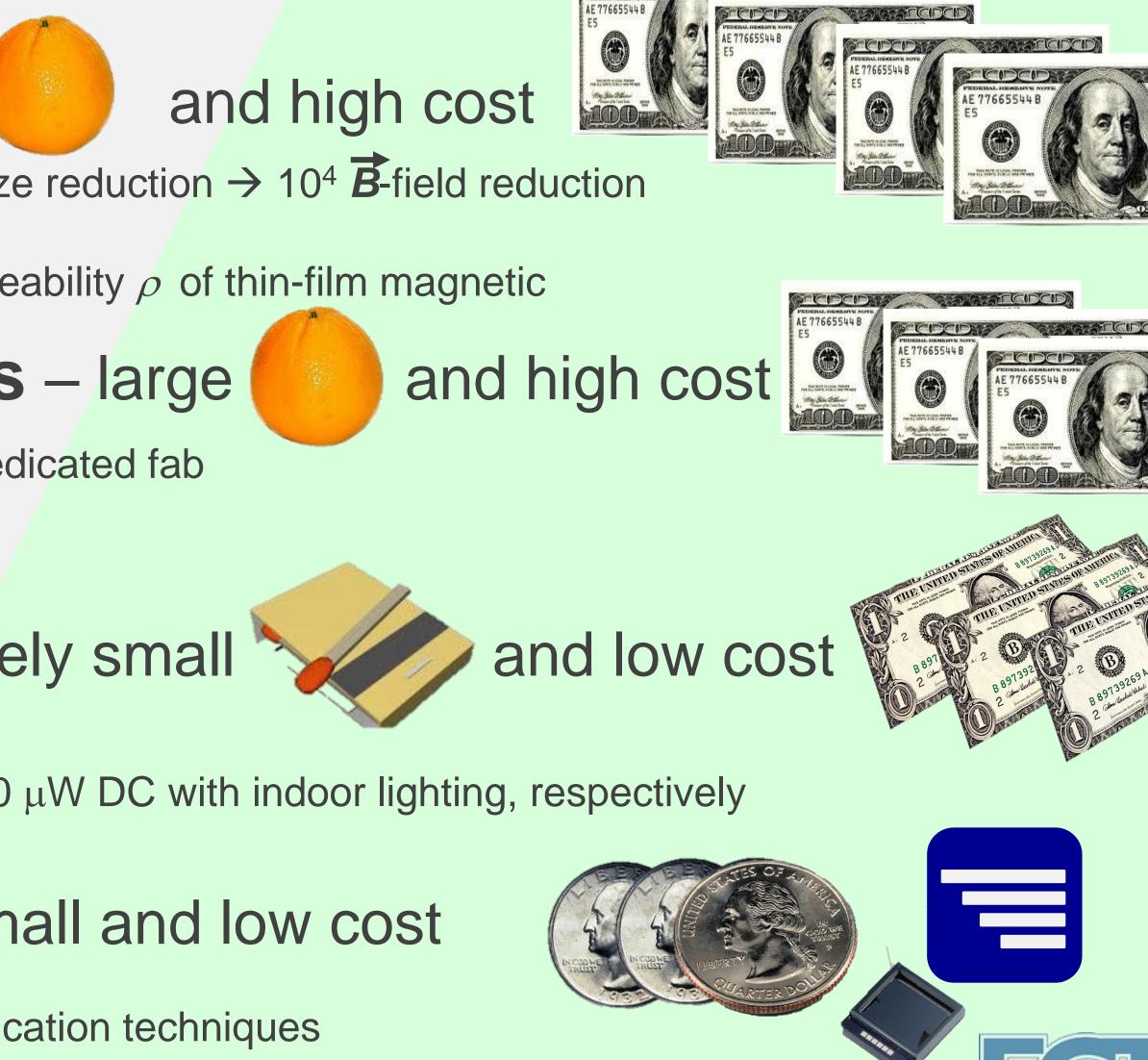
 $\diamond~$ e.g. SolChip and Panasonic are 5 and 60 μW DC with indoor lighting, respectively



Piezoelectric vibration – small and low cost

MicroGen uses standard piezo-MEMS fabrication techniques
100-1000 μW DC currently, where 100 μW will power most wireless sensors

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D









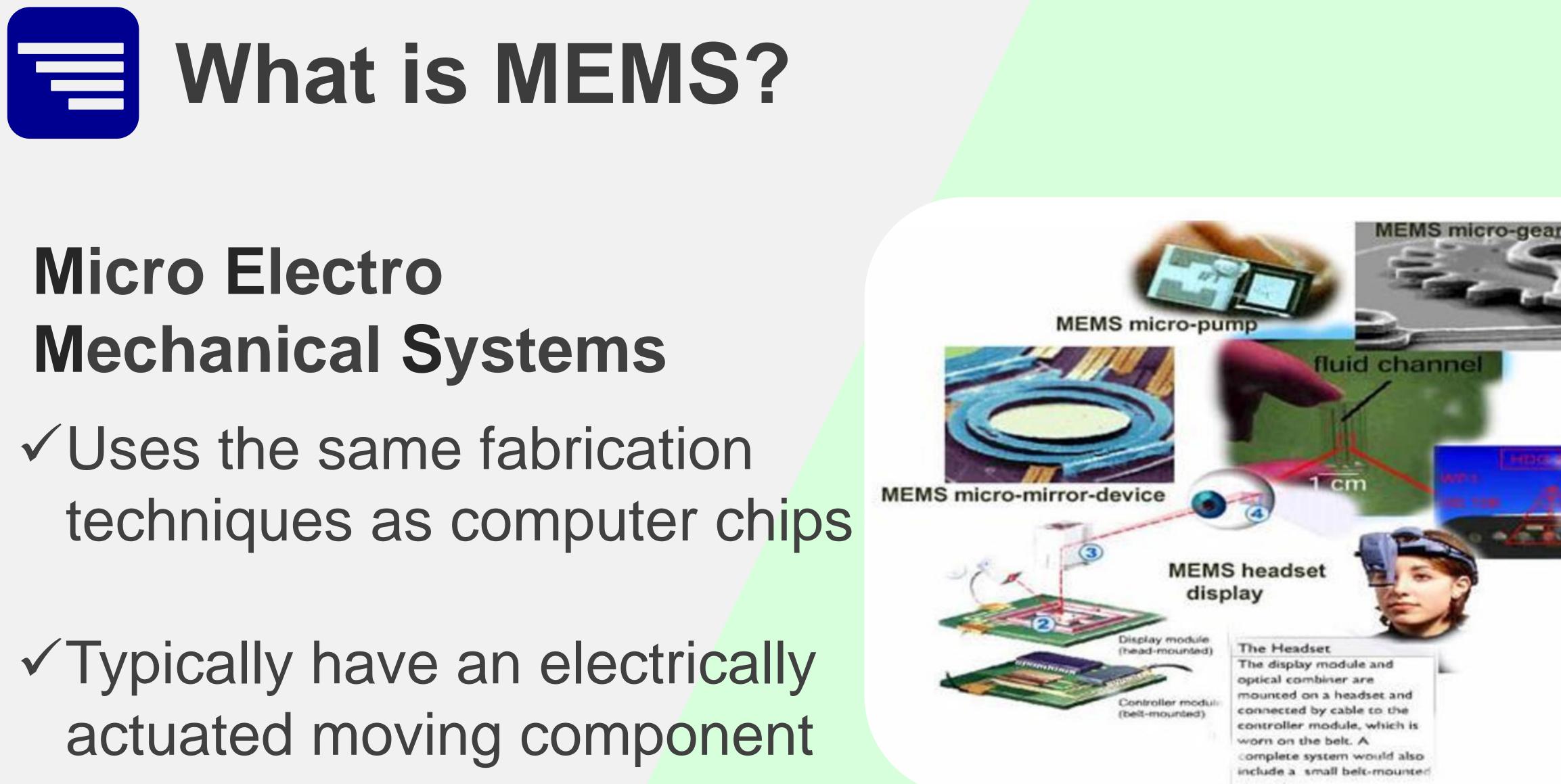
Large device, several hundred \$ each











(but not always)

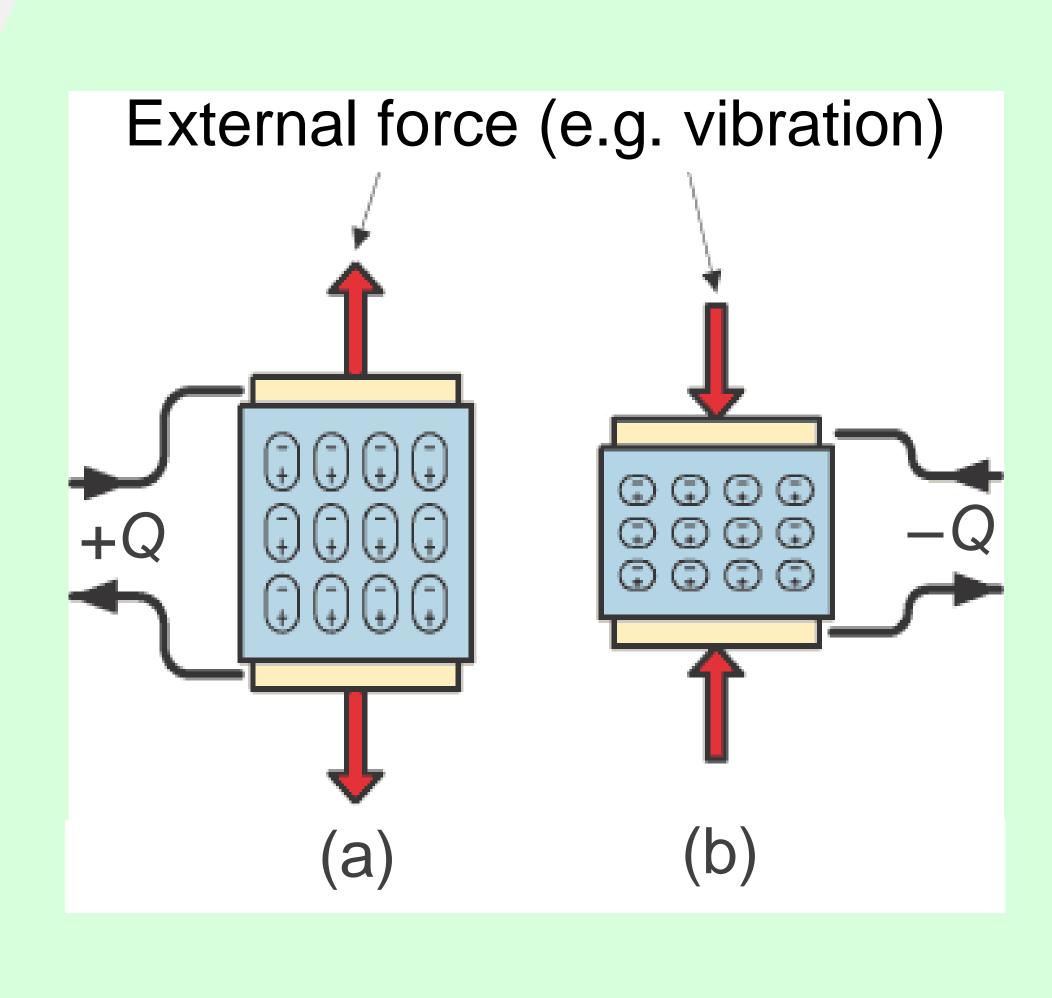


What is piezoelectricity?

Piezoelectricity – Discovered in 1885 by the Curie Brothers

Mechanically straining a piezoelectric crystal causes asymmetry inducing an internal electric **D**-field pushing and pulling charge Q.

When the piezo-capacitor is electrically connected to ground charge Q is pushed and pulled from its electrodes creating alternating current (AC). This AC is then converted to DC electricity and stored.









Low cost wafer-level packaged piezoelectric MEMS vibration energy harvestor

BOLT[™] – Used for industrial and building applications

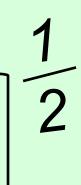
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Resonant frequency $f_1 \sim \frac{\left[k\right]^2}{M}$

external vibration <

See video of simple operation





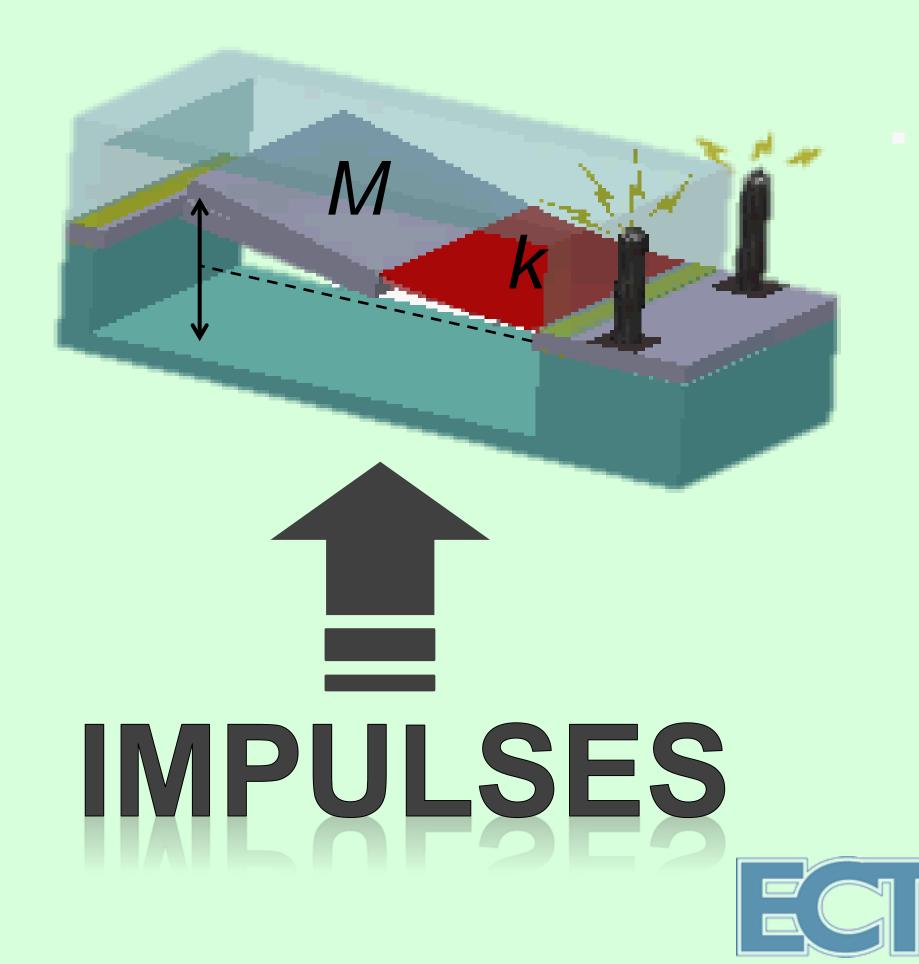
2014



A high quality factor Q oscillator will "ring" at its "natural" or resonant frequency when impulsed.

VIBE™ – Used for Intelligent Tire Systems (ITS) tire mounted TPMS apps

Click here to view demo







Piezoelectric MEMS Vibration Energy Harvesters and Power Cells







Superior power generation from small form-factors

Low cost, long life, high reliability and green energy

In volume production at X-FAB in Germany

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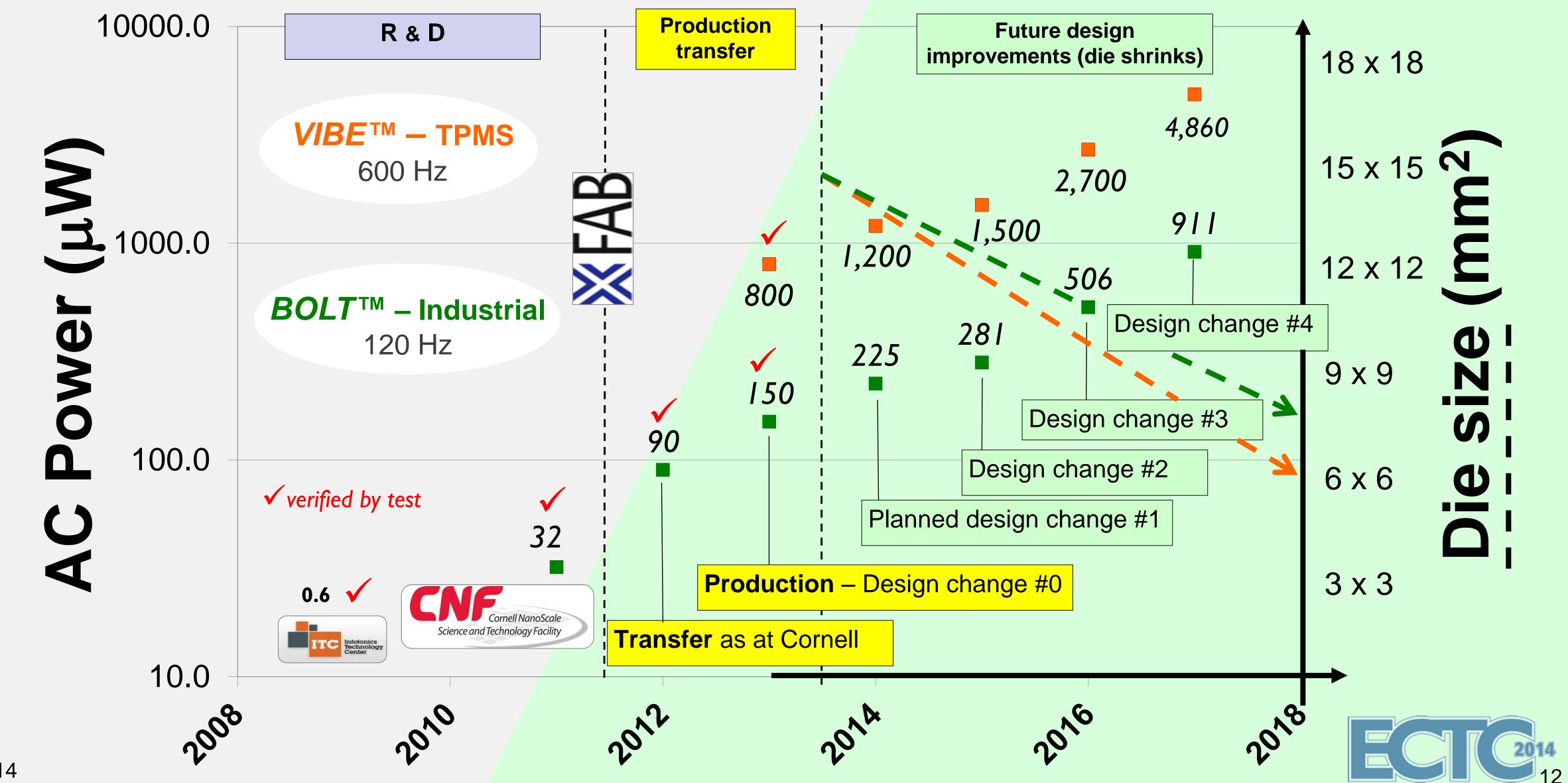
wafer-level packaged harvester







B Power/ chip size roadmap





- - Most current EH types are expensive
 - Most current EH types are large

Bottom line:

- \checkmark Need to develop more low cost, small EH sources
- Need more companies to produce such devices (need more investment \$\$\$)

Conclusion – Need for IoT applications

Assumption: A low cost, small wireless sensor node (including IC, sensor, and RF radio) requires a low cost, small power source

< \$1-2 each in volume







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